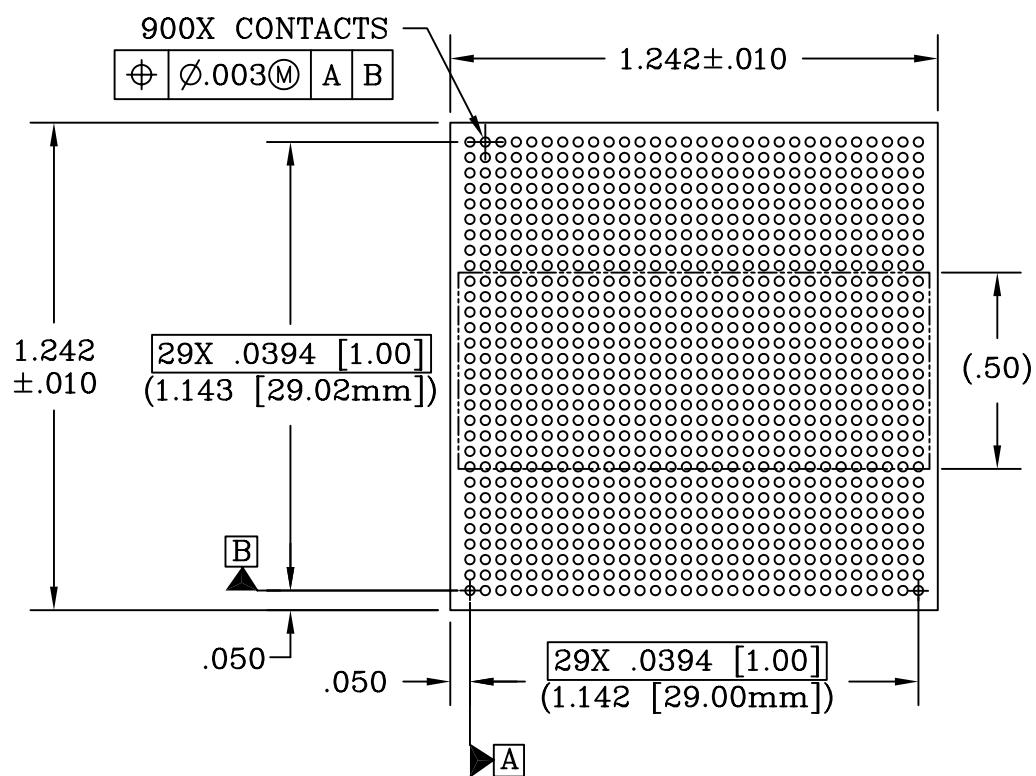


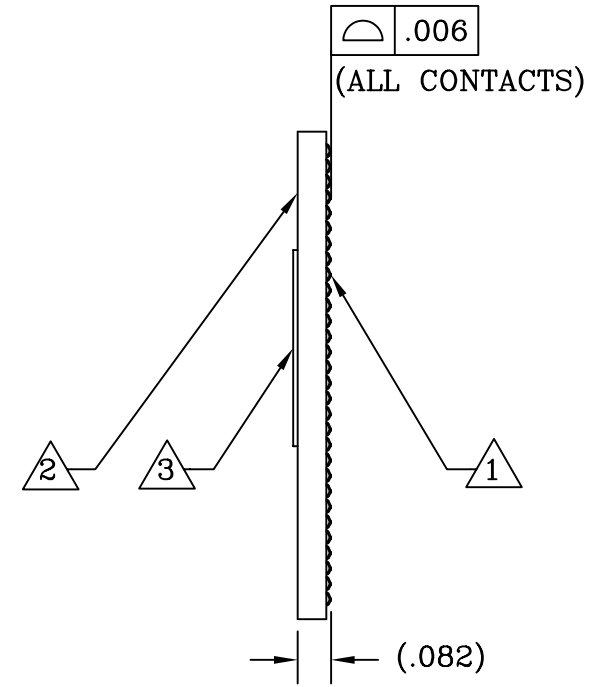
REV	DESCRIPTION	DATE	BY
A	NEW DRAWING	05/19/05	H.N.
B	UPDATED DRAWING	04/17/06	H.N.

F6616

TOP VIEW



RS VIEW

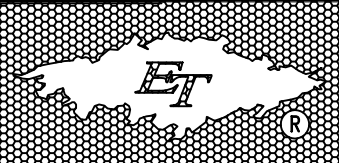


NOTES:

- 1. CONTACT MATERIAL: BERYLLIUM COPPER.
CONTACT PLATING: HARD GOLD OVER NICKEL.
- 2. INSULATOR MATERIAL: FR4
- 3. KAPTON TAPE FOR PICK AND PLACE.
- 4. REFER TO ET HiLo APPLICATION GUIDELINES FOR LAND PATTERN, STENCIL DESIGN AND KEEP OUT ZONE RECOMMENDATIONS.

UNLESS OTHERWISE SPECIFIED:
 DIMENSIONS ARE IN INCHES
 (ALTERNATE) DIMENSIONS ARE IN mm
 TOLERANCES:
 ANGLES: ±
 FRACTIONS: ±1/64
 DECIMALS:
 .XX ±.010
 .XXX ±.005
 .XXXX ±.0005

ALL DIMENSIONS ARE IN INCHES UNLESS OTHERWISE SPECIFIED



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 TEL:(408)982-0660 FAX:(408)982-0664

SHEET: 1 OF 1	DATE: 05/19/05	REVISION: B	ASSEMBLY DRAWING
CHECKED: Perry Munroe	DRAWN: Huy Nguyen		
Scale 2:1			DO NOT SCALE DRAWING
			DESCRIPTION: HLS-300900-B-10